

Docket No.
CS02-101

Declaration and Power of Attorney For Patent Application

English Language Declaration

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled
Structure and Method For Fabricating a Bond Pad Structure

the specification of which

(check one)

☒ is attached hereto.

☐ was filed on _____ as United States Application No. or PCT International
Application Number _____
and was amended on _____

(if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or (f), or 365(b) of any foreign application(s) for patent, or plant breeder's rights certificate(s), or 365(a) of any PCT International application which designated at least one country other than the United States of America, listed below and have also identified below, by checking the box, any foreign application for patent, inventor's or plant breeder's rights certificate(s), or any PCT international application having a filing date before that of the application on which priority is claimed.

| Prior Foreign Application(s) | | | Priority Not Claimed |
|------------------------------|--------------------|---------------------------------|--------------------------|
| _____ (Number) | _____ (Country) | _____ (Day/Month/Year Filed) | <input type="checkbox"/> |
| _____ (Number) | _____ (Country) | _____ (Day/Month/Year Filed) | <input type="checkbox"/> |
| _____ (Number) | _____ (Country) | _____ (Day/Month/Year Filed) | <input type="checkbox"/> |

I hereby claim the benefit under 35 U.S.C. Section 119(e) of any United States provisional application(s) listed below:

| | |
|--------------------------|---------------|
| _____ | _____ |
| (Application Serial No.) | (Filing Date) |
| _____ | _____ |
| (Application Serial No.) | (Filing Date) |
| _____ | _____ |
| (Application Serial No.) | (Filing Date) |

I hereby claim the benefit under 35 U. S. C. Section 120 of any United States application(s), or Section 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. Section 112, I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, C. F. R., Section 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application:

| | | |
|--------------------------|---------------|--------------------------------|
| _____ | _____ | _____ |
| (Application Serial No.) | (Filing Date) | (Status) |
| | | (patented, pending, abandoned) |
| _____ | _____ | _____ |
| (Application Serial No.) | (Filing Date) | (Status) |
| | | (patented, pending, abandoned) |
| _____ | _____ | _____ |
| (Application Serial No.) | (Filing Date) | (Status) |
| | | (patented, pending, abandoned) |

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. *(list name and registration number)*

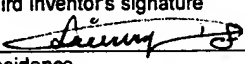
William J Stoffel Reg 39,390

Send Correspondence to: William J Stoffel Customer no. 30402
 1735 Market St - Ste A
 PMB 455
 Philadelphia, PA 19103

Direct Telephone Calls to: *(name and telephone number)*
 William Stoffel 215-670-2455

| | |
|---|------|
| Full name of sole or first inventor Zhang Fan | |
| Sole or first inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
| | |

| | | |
|--|------|-----------|
| Full name of second inventor, if any 2. Zhang Bei Chao | | 22/oct/03 |
| Second inventor's signature | Date | |
| B.K. 703, #10-60, Chua Chu Kang Str 53, Singapore 680703 | | |
| Residence Australia B.K. 703, #10-60, Chua Chu Kang Str 53, Singapore 680703 SG | | |
| Citizenship Australia | | |
| Post Office Address | | |
| | | |

| | |
|---|---------------|
| Full name of third inventor, if any | |
| 3. <u>Liu Wuping</u> | |
| Third inventor's signature | Date |
|  | Oct. 22, 2003 |
| Residence | |
| Block 316, #03-119, Clementi Ave. 4. Singapore 120316 SG | |
| Citizenship | |
| China | |
| Post Office Address | |
| | |

| | |
|--------------------------------------|------|
| Full name of fourth inventor, if any | |
| 4. <u>Chok Kho Liep</u> | |
| Fourth inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
| | |

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|-------------------------------------|------|
| Full name of fifth inventor, if any | |
| <u>Hsia Liang Choo</u> | |
| Fifth inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
| | |

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|-------------------------------------|------|
| Full name of sixth inventor, if any | |
| <u>Lim Yeow Kheng</u> | |
| Sixth inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
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| Full name of seventh inventor, if any Alan Cuthbertson | |
| Seventh inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
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|---|------|--------------|
| Full name of eighth inventor, if any Tan Juan Boon | | 27 Oct. 2003 |
| Eighth inventor's signature <i>Tan Juan Boon</i> | Date | |
| Residence 136A Hillview Avenue, #07-04 Merawoods, Singapore 669605 S G | | |
| Citizenship Malaysian | | |
| Post Office Address | | |
| | | |

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|-------------------------------------|------|
| Full name of ninth inventor, if any | |
| Ninth inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
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|-------------------------------------|------|
| Full name of tenth inventor, if any | |
| Tenth inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
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Prior Foreign Application(s)

Priority Not Claimed

| | | | |
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| _____ (Number) | _____ (Country) | _____ (Day/Month/Year Filed) | <input type="checkbox"/> |
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| _____ (Application Serial No.) | _____ (Filing Date) |
| _____ (Application Serial No.) | _____ (Filing Date) |

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|-----------------------------------|------------------------|---|
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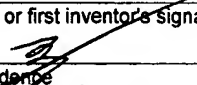
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PMB 455
Philadelphia, PA 19103

Direct Telephone Calls to: *(name and telephone number)*
William Stoffel 215-670-2455

| | |
|---|----------------------------|
| Full name of sole or first inventor Zhang Fan | |
| Sole or first inventor's signature  | Date 28 Oct 2008 |
| Residence Blk 552, #11-45, Choa Chu Kang St. 52, Singapore 680552 | |
| Citizenship China | |
| Post Office Address 60 Woodlands Industrial Park D. St. 2. Singapore 738406 | |

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| Full name of second inventor, if any 2. Zhang Bei Chao | |
| Second inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
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|-------------------------------------|------|
| Full name of third inventor, if any | |
| 3. <u>Liu Wuping</u> | |
| Third inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
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| Full name of fourth inventor, if any | |
| 4. <u>Chok Kho Liep</u> | 22-0ct-03 |
| Fourth inventor's signature | Date |
| Residence | |
| 21 HUME AVE, #09-02 SINGAPORE 598728 SG | |
| Citizenship | |
| SINGAPORE | |
| Post Office Address | |
| 60 WOODLANDS INDUSTRIAL PARK, ST 2, SINGAPORE 738406 | |
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|---|-----------|
| Full name of fifth inventor, if any | |
| <u>Hsia Liang Choo</u> | |
| Fifth inventor's signature | Date |
| <u>Liang Choo Han</u> | 27-Oct-03 |
| Residence | |
| 47 Woodgrove Avenue, Singapore 738622 SG | |
| Citizenship | |
| USA | |
| Post Office Address | |
| 60 Woodlands Industrial park st. 2 Singapore 738406 | |
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|---|-----------|
| Full name of sixth inventor, if any | |
| <u>Lim Yeow Kheng</u> | |
| Sixth inventor's signature | Date |
| <u>Lim Yeow Kheng</u> | 02 Nov 03 |
| Residence | |
| 31K 63, Kallang Bahru, #08-407, Singapore 330063 SG | |
| Citizenship | |
| Singapore | |
| Post Office Address | |
| Same As above | |
| | |

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| Full name of seventh inventor, if any Alan Cuthbertson | |
| Seventh inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
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| Full name of eighth inventor, if Tan Juan Boon | |
| Eighth inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
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| Full name of ninth inventor, if any | |
| Ninth inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
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| Full name of tenth inventor, if any | |
| Tenth inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
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Docket No.
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Priority Not Claimed

(Number)

(Country)

(Day/Month/Year Filed)

☐

(Number)

(Country)

(Day/Month/Year Filed)

☐

(Number)

(Country)

(Day/Month/Year Filed)

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| _____ | _____ | _____ |
| (Application Serial No.) | (Filing Date) | (Status) |
| | | (patented, pending, abandoned) |

| | | |
|--------------------------|---------------|--------------------------------|
| _____ | _____ | _____ |
| (Application Serial No.) | (Filing Date) | (Status) |
| | | (patented, pending, abandoned) |

| | | |
|--------------------------|---------------|--------------------------------|
| _____ | _____ | _____ |
| (Application Serial No.) | (Filing Date) | (Status) |
| | | (patented, pending, abandoned) |

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Philadelphia, PA 19103

Direct Telephone Calls to: *(name and telephone number)*
William Stoffel 215-670-2455

| | |
|---|------|
| Full name of sole or first inventor Zhang Fan | |
| Sole or first inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
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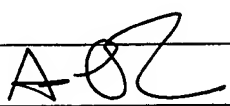
| | |
|--|------|
| Full name of second inventor, if any 2. Zhang Bei Chao | |
| Second inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
| | |

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|--|------|
| Full name of third inventor, if any 3. <u>Liu Wuping</u> | |
| Third inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
| | |

| | |
|--|------|
| Full name of fourth inventor, if any 4. <u>Chok Kho Ljep</u> | |
| Fourth inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
| | |

| | |
|--|------|
| Full name of fifth inventor, if any <u>Hsia Liang Choo</u> | |
| Fifth inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
| | |

| | |
|---|------|
| Full name of sixth inventor, if any <u>Lim Yeow Kheng</u> | |
| Sixth inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
| | |

| | |
|---|-----------------|
| Full name of seventh inventor, if any Alan Cuthbertson | |
| Seventh inventor's signature  | Date 6/11/03 |
| Residence 7, THE OAKS, MAFKEN, NEWCASTLE UPON TYNE, ENGLAND NE20 0TG | |
| Citizenship BRITISH | |
| Post Office Address | |
| | |

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|--|------|
| Full name of eighth inventor, if any Tan Juan Boon | |
| Eighth inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
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|-------------------------------------|------|
| Full name of ninth inventor, if any | |
| Ninth inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
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|-------------------------------------|------|
| Full name of tenth inventor, if any | |
| Tenth inventor's signature | Date |
| Residence | |
| Citizenship | |
| Post Office Address | |
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